

# Solid State Drive HG6 Series

#### **Key Features**

- Hot-Plug/OS-Aware Hot Removal
- ClickConnect (a latch solution for internal cabled system application) supported (2.5-inch only)
- Deterministic Zeroing TRIM supported
- SED model supports TCG OPAL ver. 2.0 and Wipe Technology based on AES 256 hardware
- WWN (World Wide Name) supported
- Strong & highly-efficient ECC named QSBC<sup>TM \*1</sup>
- Serial ATA DIPM (Device Initiated Power Management), HIPM (Host Initiated Power Management) and Device Sleep are supported for reduced power consumption
- Read only mode supported for emergency NOTE:\*1) QSBC is a trademark of Toshiba Corporation



#### **Applications**

For General-purpose notebook PCs

## **Specifications and Features**

Form Factor	2.5-inch (9.5 mmH)	2.5-inch (7.0 mmH)	mSATA <sup>™ *1</sup> Module	M.2 2280-D2 (Double-sided)	M.2 2280-S2 (Single-sided)
Connector Type	Standa	rd SATA	mSATA™*1	M.2	B-M
Memory		TOSHIBA	MLC NAND Flash Memo	ory	
Interface *2		ACS-2, SAT	A revision 3.1 1.5/3/6 G	bit/s	
Capacity *2	60/128/25	56/512 GB	60/128/25	56/512 GB	128/256 GB
Performance *2*3		Sequential Re	ead: up to 534 MB/s{510	MiB/s}	
		Sequential W	rite: up to 482 MB/s{460	MiB/s}	
Supply Voltage	5.0 V	±5 %		3.3 V ±5 %	
Power	Active: 3	Active: 3.3 W typ. Active: 3.2 W typ.			
Consumption	Idle: 125 mW typ. Idle: 65 mW typ.				
Temperature	Operating: 0 °C - 70 °C		Operating: 0 °C - 80 °C		
	(case temperature)		(components temperature)		
	Non-operating: -40 °C – 85 °C Non-operating: -40 °C – 85 °C				
Shock	14.7 km/s <sup>2</sup> {1500 G} at 0.5 ms				
Vibration	Operating / Non-operating: 196 m/s <sup>2</sup> {20 G} at 10-2,000 Hz				
Reliability		Mean Time to	Failure (MTTF): 1,500,00	00 hours	
		Product	Life: Approximately 5 yea	ars	
Size	100.0 mm x 69.85 mm	100.0 mm x 69.85 mm	50.95 mm x 30.0 mm	80.0 mm x 22.0 mm	80.0 mm x 22.0 mm
	x 9.5 mm	x 7.0 mm	x 3.95 mm	x 3.58 mm	x 2.23 mm
Weight	51 - 55 g typ.	49 - 53 g typ.	7.3 - 7.7 g typ.	7.0 - 9.3 g typ.	6.4 - 6.6 g typ.
More Features	Translation mode which enables any drive configuration				
	28-bit LBA mode commands and 48-bit LBA mode commands support				
	Automatic retries and corrections for read errors				
	NCQ (Native Comma	and Queuing) function supp	orted		

UL, CSA, TÜV, KC, BSMI, CE, C-Tick

Compliance

Products and specifications discussed herein are for reference purposes only and are subject to change without notice. All information discussed herein is provided on an "as is" basis, without warranties of any kind. Before creating and producing designs and using, customers must refer to and comply with the latest versions of the product specifications.

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<sup>\*1)</sup> mSATA  $^{\mbox{\tiny M}}$  is a trademark of Serial ATA International Organization

<sup>\*2) 1</sup> MB = 1,000,000 bytes, 1 GB = 1,000,000,000 bytes, 1 Gbit = 1,000,000,000 bits

<sup>\*3) 1</sup> MiB (mebibytes) = 2<sup>20</sup> bytes = 1,048,576 bytes



# **Ordering Information**

THN SX X XXXG X X X 1 2 3 4 5 6 7

1. Model Name THN: Toshiba NAND drive

2. Model Type SN: Non-SED, SF: SED

3. Controller Type J: Type J

4. Capacity 060G / 128G / 256G / 512G / ...

060G is 60 GB, 128G is 128 GB, 256G is 256 GB and 512G is 512 GB

(1 GB = 1,000,000,000 bytes)

5. Form Factor B: 2.5-inch case (9.5 mm height), C: 2.5-inch case (7.0 mm height),

A/M: mSATA Module type, 8/V/D: M.2 2280 Module type

6. Host I/F Type S: Standard SATA, C: mSATA, N: M.2 B-M SATA type

7. NAND Type U: MLC



# **Product Line Up**

THNSNJ128GVNU (S2) *2  THNSNJ256G8NU (D2) *1  THNSNJ256GVNU (S2) *2  THNSNJ512GDNU (D2) *1  THNSFJ128GBSU  THNSFJ128GBSU  THNSFJ128GBSU  THNSFJ128GBSU  THNSFJ1256GBSU  THNSFJ126GSU  THNSFJ128GSU  THNSFJ126GSU  THNSFJ126GSU  THNSFJ126GSU  THNSFJ126GSU  THNSFJ126GSU  THNSFJ128GCSU  THNSFJ128GCSU  THNSFJ128GCSU  THNSFJ128GCSU  THNSFJ128GCSU  THNSFJ128GCSU  THNSFJ126GCSU  THNSFJ126GCSU  THNSFJ126GCSU  THNSFJ126GCSU  THNSFJ126GCSU  THNSFJ126GCSU  THNSFJ126GCSU  THNSFJ126GCSU  THNSFJ126GCSU  THNSFJ128GMCU  THNSFJ128GBNU (D2) *1  THNSFJ128GSNU (D2) *1  THNSFJ128GSNU (D2) *1  THNSFJ128GSNU (D2) *1  THNSFJ256GSNU (D2) *2  THNSFJ256GSNU (D2) *1  THNSFJ25GGSNU (D2) *1  THNSFJ25GGSU (D2) *1  THNSFJ25GGSU (D2) *1  THNSFJ25GGSU (D2) *1  THNSF	Product Number	Capacity	Form Factor	Note
THNSNJ256GBSU   256 GB   2.5-inch 9.5 mm case   Non-SED	THNSNJ060GBSU	60 GB		Non-SED
THNSNJ256GBSU 256 GB THNSNJ128GCSU 512 GB THNSNJ128GCSU 128 GB THNSNJ128GCSU 128 GB THNSNJ128GCSU 128 GB THNSNJ1212GCSU 512 GB THNSNJ128GCSU 512 GB THNSNJ128GMCU 512 GB THNSNJ128GMCU 128 GB THNSNJ128GMCU 525 GB THNSNJ128GMCU 512 GB THNSNJ128GMU (D2) **1	THNSNJ128GBSU	128 GB	2 F inch 0 F mm case	Non-SED
THNSNJ128GCSU	THNSNJ256GBSU	256 GB	2.5-inch 9.5 mm case	Non-SED
THNSNJ128GCSU	THNSNJ512GBSU	512 GB		Non-SED
THNSNJ256GCSU   256 GB	THNSNJ060GCSU	60 GB		Non-SED
THNSNJ256GCSU 256 GB THNSNJ1512GCSU 512 GB THNSNJ128GMCU 128 GB THNSNJ128GMCU 128 GB THNSNJ128GMCU 256 GB THNSNJ128GMCU 512 GB THNSNJ128GMCU 512 GB THNSNJ128GMCU 512 GB THNSNJ128GMU (D2) '1 60 GB THNSNJ128GNU (D2) '1 128 GB THNSNJ128GNU (S2) '2 THNSNJ128GNU (S2) '2 THNSNJ125GGWCU (S2) '2 THNSNJ125GGWCU 512 GB THNSNJ128GNU (D2) '1 512 GB THNSNJ128GNU (D2) '1 512 GB THNSFJ128GBSU 128 GB THNSFJ128GBSU 512 GB THNSFJ128GCSU 512 GB THNSFJ126GCSU 512 GB THNSFJ128GMCU 512 GB THNSFJ128GNCU (S2) '2 THNSFJ256GSNU (D2) '1 128 GB	THNSNJ128GCSU	128 GB	2.5 in th. 7.0 mm and	Non-SED
THNSNJ060GMCU	THNSNJ256GCSU	256 GB	2.5-inch 7.0 mm case	Non-SED
THNSNJ128GMCU	THNSNJ512GCSU	512 GB		Non-SED
THNSNJ256GMCU 256 GB MSATA module Non-SED Non-SED THNSNJ512GACU 512 GB Non-SED THNSNJ128G8NU (D2) "1 60 GB Non-SED THNSNJ128G8NU (D2) "1 128 GB Non-SED THNSNJ128G8NU (D2) "1 256 GB Non-SED THNSNJ128G9NU (S2) "2 Non-SED THNSNJ256G8NU (D2) "1 512 GB Non-SED THNSNJ512GDNU (D2) "1 512 GB SED THNSFJ128GBSU 256 GB SED THNSFJ128GSU 512 GB SED THNSFJ128GSU 512 GB SED THNSFJ128GCSU 128 GB SED THNSFJ128GCSU 128 GB SED THNSFJ128GCSU 128 GB SED THNSFJ128GCSU 512 GB SED THNSFJ126GCSU 512 GB SED THNSFJ128GMCU 128 GB SED THNSFJ128GMCU 512 GB SED THNSFJ128GNU (D2) "1 60 GB SED THNSFJ128G8NU (D2) "1 128 GB SED THNSFJ128G8NU (D2) "1 526 GB SED THNSFJ128GNU (D2) "1 526 GB SED	THNSNJ060GMCU	60 GB		Non-SED
THNSNJ256GMCU 256 GB THNSNJ512GACU 512 GB THNSNJ128GRNU (D2) '1 60 GB THNSNJ128GRNU (D2) '1 128 GB THNSNJ128GRNU (D2) '1 256 GB THNSNJ256GSNU (D2) '1 256 GB THNSNJ256GSNU (D2) '1 512 GB THNSNJ512GDNU (D2) '1 512 GB THNSFJ128GBSU 128 GB THNSFJ128GBSU 128 GB THNSFJ126GBSU 512 GB THNSFJ126GSU 512 GB THNSFJ126GCSU 60 GB THNSFJ128GCSU 128 GB THNSFJ126GCSU 512 GB THNSFJ128GMCU 128 GB THNSFJ128GMCU 512 GB THNSFJ128GNU (D2) '1 60 GB THNSFJ128GNU (D2) '1 128 GB THNSFJ128GNU (D2) '1 526 GB	THNSNJ128GMCU	128 GB	6474	Non-SED
THNSNJ060G8NU (D2) *1	THNSNJ256GMCU	256 GB	mSATA module	Non-SED
THNSNJ128G8NU (D2) 1	THNSNJ512GACU	512 GB		Non-SED
THNSNJ128GVNU (S2) *2  THNSNJ256G8NU (D2) *1  THNSNJ256G8NU (D2) *1  THNSNJ256GVNU (S2) *2  THNSFJ060GBSU  THNSFJ128GBSU  THNSFJ128GBSU  THNSFJ128GBSU  THNSFJ12GBSU  THNSFJ12GBSU  THNSFJ12GBSU  THNSFJ12GBSU  THNSFJ12GBSU  THNSFJ12GBSU  THNSFJ12GBSU  THNSFJ12GBSU  THNSFJ12BGSU  THNSFJ12BGSU  THNSFJ12BGCSU  THNSFJ12BGCCSU	THNSNJ060G8NU (D2) *1	60 GB		Non-SED
THNSNJ256G8NU (D2) *1         256 GB         M.2 2280 module         Non-SED           THNSNJ256GVNU (S2) *2         ***         Non-SED           THNSNJ256GVNU (D2) *1         512 GB         Non-SED           THNSFJ060GBSU         60 GB         SED           THNSFJ128GBSU         128 GB         SED           THNSFJ12GBSU         512 GB         SED           THNSFJ12GGSU         60 GB         SED           THNSFJ128GCSU         128 GB         SED           THNSFJ25GGSU         256 GB         SED           THNSFJ12GCSU         512 GB         SED           THNSFJ12AGMCU         60 GB         SED           THNSFJ25GGMCU         256 GB         SED           THNSFJ12AGACU         512 GB         SED           THNSFJ12AGACU         512 GB         SED           THNSFJ12BGNU (D2) *1         128 GB         SED           THNSFJ12BGNU (D2) *1         SED         SED           THNSFJ12SGGNU (D2) *1 <td>` ,</td> <td>128 GB</td> <td></td> <td>Non-SED</td>	` ,	128 GB		Non-SED
THNSNJ512GDNU (D2)*1         512 GB         Non-SED           THNSFJ060GBSU         60 GB         SED           THNSFJ128GBSU         128 GB         SED           THNSFJ256GBSU         256 GB         SED           THNSFJ512GBSU         512 GB         SED           THNSFJ060GCSU         60 GB         SED           THNSFJ128GCSU         128 GB         SED           THNSFJ512GCSU         256 GB         SED           THNSFJ060GMCU         60 GB         SED           THNSFJ128GMCU         128 GB         SED           THNSFJ512GACU         256 GB         MSATA module           THNSFJ512GACU         512 GB         SED           THNSFJ128GNU (D2)*1         60 GB         SED           THNSFJ128GNU (D2)*1         128 GB         SED           THNSFJ128GNU (D2)*1         128 GB         SED           THNSFJ128GVNU (S2)*2         SED         M.2 2280 module           THNSFJ256GSNU (D2)*1         256 GB         SED           THNSFJ256GVNU (S2)*2         SED         SED	THNSNJ256G8NU (D2) *1	256 GB	M.2 2280 module	Non-SED
THNSFJ060GBSU         60 GB         SED           THNSFJ128GBSU         128 GB         SED           THNSFJ256GBSU         256 GB         SED           THNSFJ512GBSU         512 GB         SED           THNSFJ060GCSU         60 GB         SED           THNSFJ128GCSU         128 GB         SED           THNSFJ256GCSU         256 GB         SED           THNSFJ512GCSU         512 GB         SED           THNSFJ060GMCU         60 GB         SED           THNSFJ128GMCU         128 GB         MSATA module           THNSFJ512GACU         512 GB         SED           THNSFJ128GNU (D2) *1         60 GB         SED           THNSFJ128GNU (D2) *1         128 GB         SED           THNSFJ128GVNU (S2) *2         M.2 2280 module         SED           THNSFJ256GSNU (D2) *1         256 GB         SED           THNSFJ256GVNU (S2) *2         SED         SED	THNSNJ256GVNU (S2) *2			
THNSFJ128GBSU         128 GB         2.5-inch 9.5 mm case         SED           THNSFJ256GBSU         256 GB         SED           THNSFJ512GBSU         512 GB         SED           THNSFJ128GCSU         60 GB         SED           THNSFJ128GCSU         128 GB         SED           THNSFJ256GCSU         256 GB         SED           THNSFJ32GCSU         512 GB         SED           THNSFJ060GMCU         60 GB         SED           THNSFJ128GMCU         128 GB         SED           THNSFJ512GACU         512 GB         SED           THNSFJ128GNU (D2)*1         60 GB         SED           THNSFJ128G8NU (D2)*1         128 GB         SED           THNSFJ128G8NU (D2)*1         128 GB         SED           THNSFJ128GVNU (S2)*2         M.2 2280 module         SED	THNSNJ512GDNU (D2) *1	512 GB		Non-SED
THNSFJ256GBSU         256 GB         2.5-inch 9.5 mm case         SED           THNSFJ12GBSU         512 GB         SED           THNSFJ060GCSU         60 GB         SED           THNSFJ128GCSU         128 GB         SED           THNSFJ256GCSU         256 GB         SED           THNSFJ12GCSU         512 GB         SED           THNSFJ12GCSU         60 GB         SED           THNSFJ128GMCU         128 GB         SED           THNSFJ128GMCU         256 GB         SED           THNSFJ12GACU         512 GB         SED           THNSFJ12AGCU         512 GB         SED           THNSFJ128G8NU (D2) *1         60 GB         SED           THNSFJ128G8NU (D2) *2         SED         M.2 2280 module           THNSFJ256G8NU (S2) *2         SED         SED	THNSFJ060GBSU	60 GB		SED
THNSFJ256GBSU         256 GB         SED           THNSFJ512GBSU         512 GB         SED           THNSFJ060GCSU         60 GB         SED           THNSFJ128GCSU         128 GB         SED           THNSFJ512GCSU         512 GB         SED           THNSFJ060GMCU         60 GB         SED           THNSFJ128GMCU         128 GB         SED           THNSFJ256GMCU         256 GB         SED           THNSFJ12GACU         512 GB         SED           THNSFJ12GACU         512 GB         SED           THNSFJ12BG8NU (D2) *1         60 GB         SED           THNSFJ12BG8NU (D2) *1         128 GB         SED           THNSFJ12BGVNU (S2) *2         M.2 2280 module         SED           THNSFJ256GVNU (S2) *2         SED         SED	THNSFJ128GBSU	128 GB	2 Finch 0 Fmm case	SED
THNSFJ060GCSU         60 GB           THNSFJ128GCSU         128 GB           THNSFJ256GCSU         256 GB           SED         SED           THNSFJ512GCSU         512 GB           THNSFJ060GMCU         60 GB           THNSFJ128GMCU         128 GB           THNSFJ256GMCU         256 GB           THNSFJ256GMCU         512 GB           THNSFJ060G8NU (D2) *1         60 GB           THNSFJ128G8NU (D2) *1         128 GB           THNSFJ128G8NU (D2) *2         SED           THNSFJ256G8NU (D2) *2         M.2 2280 module           SED         SED	THNSFJ256GBSU	256 GB	2.5-IIICII 9.5 IIIIII Case	SED
THNSFJ128GCSU       128 GB         THNSFJ256GCSU       256 GB         SED       SED         THNSFJ512GCSU       512 GB         THNSFJ060GMCU       60 GB         THNSFJ128GMCU       128 GB         THNSFJ256GMCU       256 GB         THNSFJ512GACU       512 GB         THNSFJ060G8NU (D2) *1       60 GB         THNSFJ128G8NU (D2) *2       SED         THNSFJ128GVNU (S2) *2       M.2 2280 module         THNSFJ256G8NU (S2) *2       SED         THNSFJ256GVNU (S2) *2       SED	THNSFJ512GBSU	512 GB		SED
THNSFJ256GCSU       256 GB       2.5-inch 7.0 mm case         THNSFJ512GCSU       512 GB       SED         THNSFJ060GMCU       60 GB       SED         THNSFJ128GMCU       128 GB       SED         THNSFJ256GMCU       256 GB       SED         THNSFJ512GACU       512 GB       SED         THNSFJ060G8NU (D2) *1       60 GB       SED         THNSFJ128G8NU (D2) *1       128 GB       SED         THNSFJ128GVNU (S2) *2       M.2 2280 module       SED         THNSFJ256GVNU (S2) *2       SED	THNSFJ060GCSU	60 GB		SED
THNSFJ256GCSU       256 GB       SED         THNSFJ512GCSU       512 GB       SED         THNSFJ060GMCU       60 GB       SED         THNSFJ128GMCU       128 GB       SED         THNSFJ256GMCU       256 GB       SED         THNSFJ512GACU       512 GB       SED         THNSFJ060G8NU (D2) *1       60 GB       SED         THNSFJ128G8NU (D2) *1       128 GB       SED         THNSFJ128GVNU (S2) *2       M.2 2280 module       SED         THNSFJ256GVNU (S2) *2       SED	THNSFJ128GCSU	128 GB	2.5 in th. 7.0 mm and	SED
THNSFJ060GMCU       60 GB         THNSFJ128GMCU       128 GB         THNSFJ256GMCU       256 GB         THNSFJ512GACU       512 GB         THNSFJ060G8NU (D2) *1       60 GB         THNSFJ128G8NU (D2) *1       128 GB         THNSFJ128GVNU (S2) *2       SED         THNSFJ256G8NU (D2) *1       256 GB         THNSFJ256GVNU (S2) *2       M.2 2280 module	THNSFJ256GCSU	256 GB	2.5-Inch 7.0 mm case	SED
THNSFJ128GMCU       128 GB       mSATA module         THNSFJ256GMCU       256 GB       SED         THNSFJ512GACU       512 GB       SED         THNSFJ060G8NU (D2) *1       60 GB       SED         THNSFJ128G8NU (D2) *1       128 GB       SED         THNSFJ128GVNU (S2) *2       M.2 2280 module       SED         THNSFJ256G8NU (D2) *1       256 GB       SED         THNSFJ256GVNU (S2) *2       SED       SED	THNSFJ512GCSU	512 GB		SED
THNSFJ256GMCU       256 GB       mSATA module         THNSFJ512GACU       512 GB       SED         THNSFJ060G8NU (D2) *1       60 GB       SED         THNSFJ128G8NU (D2) *1       128 GB       SED         THNSFJ128GVNU (S2) *2       M.2 2280 module       SED         THNSFJ256G8NU (D2) *1       256 GB       SED         THNSFJ256GVNU (S2) *2       SED       SED	THNSFJ060GMCU	60 GB		SED
THNSFJ256GMCU       256 GB       SED         THNSFJ512GACU       512 GB       SED         THNSFJ060G8NU (D2) *1       60 GB       SED         THNSFJ128G8NU (D2) *1       128 GB       SED         THNSFJ128GVNU (S2) *2       M.2 2280 module       SED         THNSFJ256G8NU (D2) *1       256 GB       SED         THNSFJ256GVNU (S2) *2       SED       SED	THNSFJ128GMCU	128 GB	6.7.	SED
THNSFJ060G8NU (D2) *1       60 GB       SED         THNSFJ128G8NU (D2) *1       128 GB       SED         THNSFJ128GVNU (S2) *2       M.2 2280 module       SED         THNSFJ256G8NU (D2) *1       256 GB       SED         THNSFJ256GVNU (S2) *2       SED	THNSFJ256GMCU	256 GB	mSATA module	SED
THNSFJ128G8NU (D2) *1 128 GB THNSFJ128GVNU (S2) *2  THNSFJ256G8NU (D2) *1 256 GB THNSFJ256GVNU (S2) *2  SED  M.2 2280 module  SED	THNSFJ512GACU	512 GB		SED
THNSFJ128G8NU (D2) *1 128 GB THNSFJ128GVNU (S2) *2  THNSFJ256G8NU (D2) *1 256 GB THNSFJ256GVNU (S2) *2  SED  M.2 2280 module  SED	THNSFJ060G8NU (D2) *1	60 GB		SED
THNSFJ256G8NU (D2) *1	THNSFJ128G8NU (D2) *1			
	THNSFJ256G8NU (D2) *1	256 GB	M.2 2280 module	SED
1 I I I I I I I I I I I I I I I I I I I	THNSFJ512GDNU (D2) *1	512 GB	_	SED

<sup>\*1)</sup> Double Side

<sup>\*2)</sup> Single Side



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# 1. General Description

The TOSHIBA SSD HG series is a memory storage device using NAND Flash Memories, which has no mechanical moving parts and provides high performance and reliability compare to Hard Disk Drive.

The drive features an ACS-2 and Serial ATA revision 3.1 interface embedded controller that requires a simplified adapter board for interfacing to a Serial ATA or Serial ATA compatible bus. The drive is distinctive for its small and light body.

# 2. Product Specifications

## 2.1. Capacity

Table 2-1. User Addressable Sectors in LBA Mode

Capacity	Total Number of User Addressable Sectors in LBA Mode		
60 GB	117,231,408		
128 GB	250,069,680		
256 GB	500,118,192		
512 GB	1,000,215,216		

NOTE: 1 GB (Gigabyte) = 1,000,000,000 bytes

Bytes per sector: 512 bytes

#### 2.2. Performance

Table 2-2. Interface Speed and Data Transfer Rate in Read/Write

	·	<u> </u>		
Parameter	Transfer Rate			
	THNSNJ060GBSU	THNSNJ128GBSU	THNSNJ256GBSU	
	THNSNJ060GCSU	THNSNJ128GCSU	THNSNJ512GBSU	
	THNSNJ060GMCU	THNSNJ128GMCU	THNSNJ256GCSU	
	THNSNJ060G8NU	THNSNJ256GMCU	THNSNJ512GCSU	
		THNSNJ128G8NU	THNSNJ512GACU	
		THNSNJ128GVNU	THNSNJ512GDNU	
		THNSNJ256G8NU		
		THNSNJ256GVNU		
Interface Speed		6 Gbit/s Max.		
Sequential Read *1	up to 534 MB/s {510 MiB/s}			
Sequential Write *1	up to 450 MB/s	up to 471 MB/s	up to 482 MB/s	
	{430 MiB/s}	{450 MiB/s}	{460 MiB/s}	

NOTE: \*1) Under the condition of measurement with 128 KiB unit sequential access

(1 KiB = 1024 bytes)



## 3. Electrical Characteristics

## 3.1. Supply Voltage

Table 3-1. Supply Voltage

	2.5-inch Case (9.5 mm/7.0 mm) mSATA / M.2 2280 I	
Allowable voltage 5.0 V ±5 % 3.3 V ±5 %		3.3 V ±5 %
Allowable noise/ripple 100 mV p-p or less		r less
Allowable supply rise time	2 −100 m	S

NOTE: These drives have over current protection circuit. (Rated current: 3.15A)

### 3.2. Power Consumption

Table 3-2. Power Consumption in 2.5-inch Case Type

Operation	2.5-inch Case (9.5 mm/7.0 mm)			
(Ta *1=25°C)	THNSNJ060GBSU	THNSNJ128GBSU	THNSNJ256GBSU	THNSNJ512GBSU
	THNSNJ060GCSU	THNSNJ128GCSU	THNSNJ256GCSU	THNSNJ512GCSU
Read *2	2.1 W typ.	2.5 W typ.	2.7 W typ.	3.0 W typ.
Write *2	2.1 W typ.	2.5 W typ.	3.2 W typ.	3.3 W typ.
Idle *3 *4	125 mW typ.	125 mW typ.	125 mW typ.	125 mW typ.
Standby *3 *4	120 mW typ.	120 mW typ.	120 mW typ.	120 mW typ
Sleep *3	120 mW typ.	120 mW typ	120 mW typ.	120 mW typ
DevSleep	5 mW max.	5 mW max.	5 mW max.	5 mW max.

Table 3-3. Power Consumption in mSATA / M.2 2280 Module Type

Operation		mSATA / M	mSATA / M.2 2280 Module		
(Ta *1=25°C)	THNSNJ060GMCU	THNSNJ128GMCU	THNSNJ256GMCU	THNSNJ512GACU	
	THNSNJ060G8NU	THNSNJ128G8NU	THNSNJ256G8NU	THNSNJ512GDNU	
		THNSNJ128GVNU	THNSNJ256GVNU		
Read *2	2.1 W typ.	2.4 W typ.	2.5 W typ.	2.9 W typ.	
Write *2	2.0 W typ.	2.4 W typ.	2.5 W typ.	3.2 W typ.	
Idle *3 *4	65 mW typ.	65 mW typ.	65 mW typ.	65 mW typ.	
Standby *3 *4	60 mW typ.	60 mW typ.	60 mW typ.	60 mW typ.	
Sleep *3	60 mW typ.	60 mW typ.	60 mW typ.	60 mW typ.	
DevSleep	5 mW max.	5 mW max.	5 mW max.	5 mW max.	

#### NOTE:

<sup>\*1)</sup> Ambient Temperature.

<sup>\*2)</sup> The values are specified at the condition causing maximum power consumption.

<sup>\*3)</sup> The values are based on using SATA power management features. The Slumber mode is used for the power consumption measurements.

<sup>\*4)</sup> The drive may internally write to NAND flash memory, while the drive is in idle or standby.

Therefore, drive power consumption may temporally change up to write power.



## 4. Environmental Conditions

## 4.1. Temperature and Humidity

Table 4-1. Temperature

Condition	Ra	Gradient	
	2.5-inch Case	mSATA / M.2 2280	
		Module	
Operating *1	0 °C (Tc) – 70 °C (Tc)	0°C (Tc) – 80°C (Tc)	30 °C (Ta)/h Max.
Non-operating	-40 °C − 85 °C		30 °C/h Max.
Under Shipment *2	-40 °C – 85 °C		30 °C/h Max.

NOTE:

Table 4-2. Humidity

Condition	Range
Operating	8 % – 90 % R.H. (No condensation)
Non-operating	8 % – 95 % R.H. (No condensation)
Under Shipment *1	5 % – 95 % R.H.

NOTE: \*1) Packaged in Toshiba's original shipping package

## 4.2. Shock and Vibration

Table 4-3. Shock

Condition	Range	
Operating	14.7 km/s <sup>2</sup> {1500 G}, 0.5 ms, half sine wave	
Non-operating	14.7 km/s- {1500 G}, 0.5 ms, nan sine wave	
Under Shipment *1	100 cm free drop	

#### NOTE:

**Table 4-4. Vibration** 

Condition	Range
Operating	196 m/s² {20 G} Peak, 10 - 2,000 Hz
Non-operating	(20 minutes per axis) x 3 axis

<sup>\*1)</sup> Ta: Ambient Temperature, Tc: Case or Components Temperature

<sup>\*2)</sup> Packaged in Toshiba's original shipping package

<sup>\*1)</sup> Apply shocks in each direction of the drive's three mutually perpendicular axes, one axis at a time. Packaged in Toshiba's original shipping package.



# 5. Compliance

TOSHIBA SSD HG series complies with the following.

Table 5-1. Compliance

Mark Name	Description	Region
UL (Underwriters Laboratories)	UL 60950-1	USA
CSA (Canadian Standard Association) *Included UL logo mark	CSA-C22.2 No.60950-1	Canada
TÜV (Technischer Überwachungs Verein)	EN 60950-1	Germany
KC	KN22 KN24	Korea
BSMI (Bureau of Standards, Metrology and Inspection)	CNS13438(CISPR Pub. 22) Class B	Taiwan
CE	EN 55022, EN 55024	Europe
C-Tick	AS/NZS CISPR Pub. 22 Class B	Australia, New Zealand

# 6. Reliability

Table 6-1. Reliability

Parameter	Value
Mean Time to Failure	1,500,000 hours
Product Life	Approximately 5 years



# 7. Mechanical Specifications

# 7.1. 2.5-inch Case (9.5 mm/7.0 mm)

**Table 7-1. Weight and Dimensions** 

Model		Weight	Width	Height	Length
0.5	THNSNJ060GBSU THNSNJ128GBSU	51 g typ.	CO 95 mam	0.5	100.0
9.5 mm	THNSNJ256GBSU THNSNJ512GBSU	55 g typ.	69.85 mm	9.5 mm	100.0 mm
7.0	THNSNJ060GCSU THNSNJ128GCSU	49 g typ.	60.05	7.0	100.0
7.0 mm	THNSNJ256GCSU THNSNJ512GCSU	53 g typ.	69.85 mm	69.85 mm 7.0 mm	100.0 mm

Figure 7-1. 2.5-inch Case (9.5 mm/7.0 mm) Drive Dimension

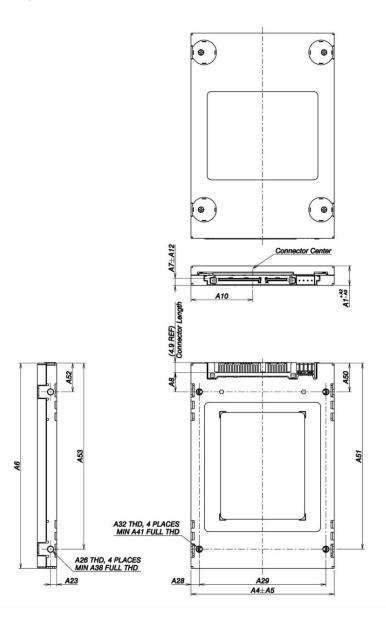




Table 7-2. Dimensions

	SFF-8200	Rev2.0 *1	_	1.1 665	
	SFF-820	1 Rev2.4	Toshiba SSD		
Dimension	SFF-822	3 Rev2.5	(Diffe	rences only)	
	Millimeters	Inches	Millimators	Inches	
	(9.5 mm/7.0 mm)	(9.5 mm/7.0 mm)	Millimeters	inches	
A1	9.50/7.00	0.374/0.276			
A2	0.20/0.00	0.008/0.000			
A3	0.20/0.50	0.008/0.020			
A4	69.85	2.750			
A5	0.25	0.010			
A6 *2	100.45 *	3.955 *	100.00±0.41	3.937±0.016	
A7	3.5	0.138			
A8	9.40	0.370	9.40±0.51	0.370±0.020	
A10 *3	-	-	30.125±0.28	1.186±0.011	
A12	0.38	0.015			
A23	3.00	0.118	3.00±0.20	0.118±0.007	
A26	M3	N/A			
A28	4.07	0.160	4.07 +0.295/-0.305	0.060 +0.011/-0.012	
A29	61.72	2.430	61.72±0.25	2.430±0.010	
A32	M3	N/A			
A38	3 #	3 #			
A41	2.5 #	2.5 #			
A50 *2	14.00	0.551	14.00±0.25	0.551±0.010	
A51 *2	90.60	3.567	90.60±0.30	3.567±0.012	
A52 *2	14.00	0.551	14.00±0.25	0.551±0.010	
A53 *2	90.60	3.567	90.60±0.30	3.567±0.012	

<sup>\* =</sup> maximum

# = minimum number of threads

### NOTE:

\*1) SFF-8200: Small Form Factor Standard

\*2) PCA, Connector not included

\*3) Connector Center defined the same as SFF-8223 All

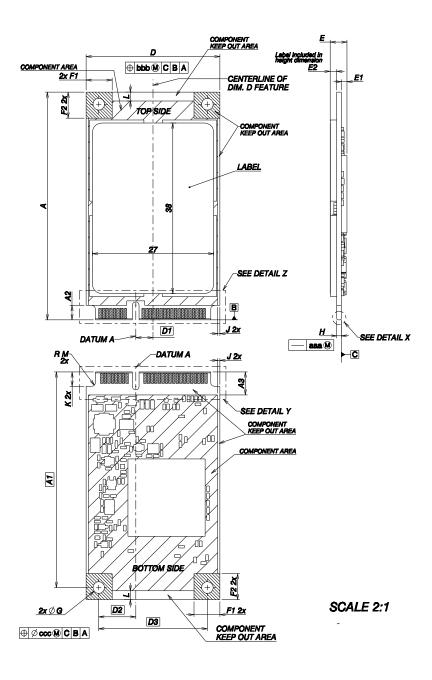


### 7.2. mSATA Module

**Table 7-3. Weight and Dimensions** 

Model	Weight	Width	Height	Length	
THNSNJ060GMCU	7.2 a tun				
THNSNJ128GMCU	7.3 g typ.	20.0	2.05	F0.05	
THNSNJ256GMCU	7.7 - 1	30.0 mm	3.95 mm	50.95 mm	
THNSNJ512GACU	7.7 g typ.				

Figure 7-2. mSATA Module Drive Dimension



NOTE: The 512 GB capacity has different outlook appearance.



Table 7-4. Dimensions and Tolerances  $^{\ast 1}$ 

	TOSHIBA				
SYMBOL	MIN	NOM	MAX	(Differences only)	
Α	50.65	50.80	50.95		
A1		48.05 BAS	SIC		
A2	3.20	-	-		
A3	5.10	-	-		
D	29.70	29.85	30.00		
D1		3.85 BAS	IC		
D2		8.25 BAS	IC		
D3		24.20 BAS	SIC		
E	-	-	4.85	3.95 max.	
E1	-	-	1.35		
E2	-	-	2.40	1.6 max.	
F1	5.65	5.80	5.95		
F2	5.65	5.80	5.95		
G	2.50	2.60	2.70		
Н	0.90	1.00	1.10		
J	0.50	-	-		
K	3.20	-	-		
L	2.00	-	-		
М	-	-	0.80		
P1	-	-	0.25		
P2	-	-	0.25		
aaa		0.22			
bbb		0.10			
ССС		0.10			

### NOTE:

Unit: mm

<sup>\*1)</sup> Thickness applies across tabs and includes plating and/or metallization.

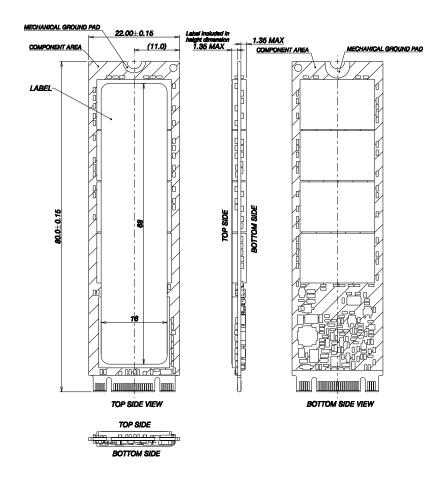


### 7.3. M.2 2280 Module

**Table 7-5. Weight and Dimensions** 

Model	Weight	Width	Height	Length
THNSNJ060G8NU(D2)	7.0 g typ.		3.58 mm	
THNSNJ128GVNU(S2)	6.4 g typ.		2.23 mm	
THNSNJ128G8NU(D2)	7.0 g typ.	22.0	3.58 mm	00.0
THNSNJ256GVNU(S2)	6.6 g typ.	22.0 mm	2.23 mm	80.0 mm
THNSNJ256G8NU(D2)	7.1 g typ.		3.58 mm	
THNSNJ512GDNU(D2)	9.3 g typ		3.58 mm	

Figure 7-3. M.2 2280 Module Drive Dimension



Unit: mm



## 8. Interface Connector

## 8.1. 2.5-inch Case (9.5 mm/7.0 mm)

Figure 8-1. 2.5-inch Case Serial ATA Interface Connector

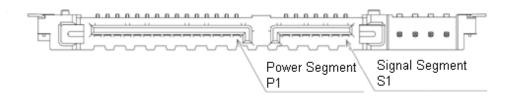


Table 8-1. 2.5-inch Case Drive Connecter Pin Assignment \*1

		Signal	segment key
	S1	GND	2 <sup>nd</sup> Mate
	S2	A+	Differential Circul Daire A (Daving Da) 2rd Adam
G: 1	S3	A-	Differential Signal Pair A (Device Rx), 3 <sup>rd</sup> Mate
Signal Segment	S4	GND	
Segment	S5	В	Differential Signal Pair B (Device Tx), 3 <sup>rd</sup> Mate
	S6	B+	Differential Signal Pair B (Device 1x), 3.4 Mate
	S7	GND	2 <sup>nd</sup> Mate
		Signal	segment "L"
		Central cor	nnector polarizer
		Power	segment "L"
	P1	Retired *2	
	P2	Retired *2	
	Р3	DEVSLP *2	Enter/Exit DevSleep
	P4	GND	1 <sup>st</sup> Mate
	P5	GND	2 <sup>nd</sup> Mate
	Р6	GND	2 <sup>nd</sup> Mate
Damas	P7	V5	5 V power, pre-charge *4, 2 <sup>nd</sup> Mate
Power Segment	P8	V5	5 V power, 3 <sup>rd</sup> Mate
Jeginent	P9	V5	5 V power, 3 <sup>rd</sup> Mate
	P10	GND	2 <sup>nd</sup> Mate
	P11	DAS/DSS *3	Drive Activity Signal, 3 <sup>rd</sup> Mate
	P12	GND	1 <sup>st</sup> Mate
	P13	V12	12 V power, pre-charge, 2 <sup>nd</sup> Mate (Unused)
	P14	V12	12 V power (Unused), 3 <sup>rd</sup> Mate
	P15	V12	12 V power (Unused), 3 <sup>rd</sup> Mate
		Power	segment key

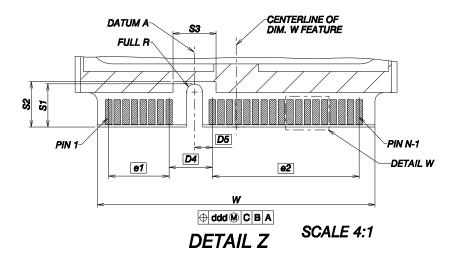
U1	N.C.	Not connected
U2	TX	For test use, Not connected
U3	UX	For test use, Not connected
U4	GND	

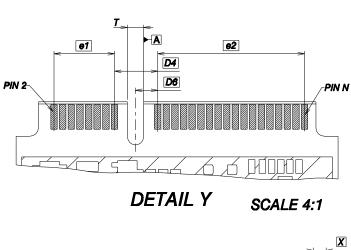
NOTE: \*1) The Mate orders are for backplane usage. Hot-Plug and OS-Aware Hot Removal are supported when using with a backplane connector. \*2) Previously, 3.3 V was assigned to pins P1, P2 and P3 by Serial ATA International Organization. \*3) DAS signal is option. DSS signal is not used for this drive. \*4) Direct connect to non pre-charge pins.



### 8.2. mSATA Module

Figure 8-2. mSATA Interface Connector





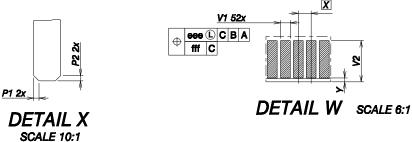




Table 8-2. Pin Assignment on mSATA Connector

Pin#	Name	Description		Pin#	Name	Description
1	Reserved	NC		2	+3.3V	3.3V Source
3	Reserved	NC		4	GND	Return Current Path
5	Reserved	NC		6	+1.5V	1.5V Source(Unused)
7	Reserved	NC		8	Reserved	NC
9	GND	Return Current Path		10	Reserved	NC
11	Reserved	NC		12	Reserved	NC
13	Reserved	NC		14	Reserved	NC
15	GND	Return Current Path		16	Reserved	NC
			Key			
17	Reserved	NC		18	GND	Return Current Path
19	Reserved	NC		20	Reserved	NC
21	GND	Return Current Path		22	Reserved	NC
23	B+	Host Receiver Differential		24	+3.3V	3.3V Source
25	B-	Signal Pair		26	GND	Return Current Path
27	GND	Return Current Path		28	+1.5V	1.5V Source(Unused)
29	GND	Return Current Path		30	Two Wire	NC
31	A-	Host Transmitter		32	Interface	NC
33	A+	Differential Signal Pair		34	GND	Return Current Path
35	GND	Return Current Path		36	Reserved	NC
37	GND	Return Current Path		38	Reserved	NC
39	+3.3V	3.3V source		40	GND	Return Current Path
41	+3.3V	3.3V source		42	Reserved	NC
43	Device Type *1	NC		44	DEVSLP	Enter/Exit DevSleep
45	Vendor	No connect at Host side		46	Reserved	NC
47	Vendor	No connect at Host side		48	+1.5V	1.5V Source(Unused)
49	DAS/DSS *2	Drive Activity Signal / Disable Staggered Spin-up		50	GND	Return Current Path
51	Presence *3	Presence Detection		52	+3.3V	3.3V Source

NOTE: \*1) Given that non-mSATA devices ground P43, configurable shared-socket designs may use this pin to identify mSATA and non-mSATA devices.

<sup>\*2)</sup> DAS signal is option. DSS signal is not used for this drive.

<sup>\*3)</sup> Presence pin is connected to GND by device side. (220 $\Omega$  Pull Down)



### 8.3. M.2 2280 Module

Figure 8-3. M.2 2280 Module Interface Connector

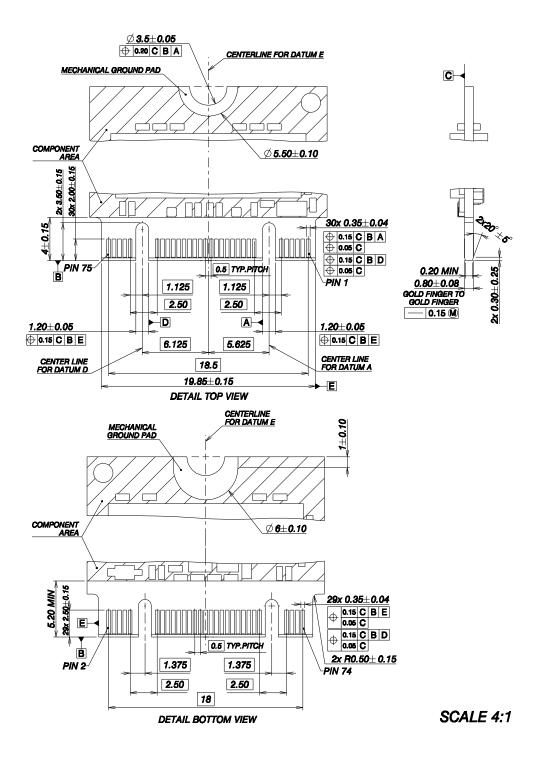




Table 8-3. Pin Assignment on M.2 2280 Module Connector

Pin#	Name	Description	Pin #	Name	Description
1	CONFIG_3	Defines module type(low)	2	+3.3V	3.3V Source
3	GND	GND	4	+3.3V	3.3V Source
5	Reserved	NC	6	Reserved	NC
7	Reserved	NC	8	Reserved	NC
9	Reserved	NC	10	DAS/DSS	Drive Activity Signal / Disable Staggered Spin-up
11	Reserved	NC			
			Notch		
Notch			20	Reserved	NC
21	CONFIG_0	Defines module type(low)	22	Reserved	NC
23	Reserved	NC	24	Reserved	NC
25	Reserved	NC	26	Reserved	NC
27	GND	GND	28	Reserved	NC
29	Reserved	NC	30	Reserved	NC
31	Reserved	NC	32	Reserved	NC
33	GND	GND	34	Reserved	NC
35	Reserved	NC	36	Reserved	NC
37	Reserved	NC	38	DEVSLP	DEVSLP signal
39	GND	GND	40	Reserved	NC
41	B+	Host Receiver Differential	42	Reserved	NC
43	B-	Signal Pair	44	Reserved	NC
45	GND	GND	46	Reserved	NC
47	A-	Host Transmitter	48	Reserved	NC
49	A+	Differential Signal Pair	50	Reserved	NC
51	GND	GND	52	Reserved	NC
53	Reserved	NC	54	Reserved	NC
55	Reserved	NC	56	MFG1	
57	GND	GND	58	MFG2	Manufacturing pin. Must be a no-connect on the host board.
Notch			Notch		
67	Reserved	NC	68	Reserved	NC
69	CONFIG_1	Defines module type(low)	70	+3.3V	3.3V Source
71	GND	GND	72	+3.3V	3.3V Source
73	GND	GND	74	+3.3V	3.3V Source
75	CONFIG_2	Defines module type(low)			



# 9. Command Descriptions

**Table 9-1. Supported ATA Command Set** 

Op-Co	ode	Command Description
001	h	NOP
06h DATA SET MANA		DATA SET MANAGEMENT
10	h	RECALIBRATE
201	h	READ SECTOR(S)
21	h	READ SECTOR(S) without retry
24	h	READ SECTOR(S) EXT
25	h	READ DMA EXT
27	h	READ NATIVE MAX ADDRESS EXT
291	h	READ MULTIPLE EXT
2Fl	h	READ LOG EXT
301	h	WRITE SECTOR(S)
31	h	WRITE SECTOR(S) without retry
341	h	WRITE SECTOR(S) EXT
351	h	WRITE DMA EXT
371	h	SET MAX ADDRESS EXT
391	h	WRITE MULTIPLE EXT
3D	h	WRITE DMA FUA EXT
3Fl	h	WRITE LOG EXT
401	h	READ VERIFY SECTOR(S)
411	h	READ VERIFY SECTOR(S) without retry
421	h	READ VERIFY SECTOR(S) EXT
451	h	WRITE UNCORRECTABLE EXT
45h	55h	Create a pseudo-uncorrectable error with logging
45h	AAh	Create a flagged error without logging
471	h	READ LOG DMA EXT
571	h	WRITE LOG DMA EXT
5Bh		TRUSTED NON-DATA (SED model only)
5Cl	h	TRUSTED RECEIVE (SED model only)
5D	h	TRUSTED RECEIVE DMA (SED model only)
5El	h	TRUSTED SEND (SED model only)
5Fl	h	TRUSTED SEND DMA (SED model only)
601	h	READ FPDMA QUEUED
61	h	WRITE FPDMA QUEUED



Op-Code		Command Description
70h		SEEK
90h		EXECUTE DEVICE DIAGNOSTIC
91	.h	INITIALIZE DEVICE PARAMETERS
92	!h	DOWNLOAD MICROCODE
92h	03h	Download with offsets and save microcode for immediate and future use.
92h	07h	Download and save microcode for immediate and future use.
93	Bh	DOWNLOAD MICROCODE DMA
93h	03h	Download with offsets and save microcode for immediate and future use.
93h	07h	Download and save microcode for immediate and future use.
ВС	)h	SMART
B0h	D0h	SMART READ DATA
B0h	D1h	SMART READ ATTRIBUTE THRESHOLDS
B0h	D2h	SMART ENABLE/DISABLE ATTRIBUTE AUTOSAVE
B0h	D3h	SMART SAVE ATTRIBUTE VALUES
B0h	D4h	SMART EXECUTE OFF-LINE IMMEDIATE
B0h	D5h	SMART READ LOG
B0h	D6h	SMART WRITE LOG
B0h	D8h	SMART ENABLE OPERATIONS
B0h	D9h	SMART DISABLE OPERATIONS
B0h	DAh	SMART RETURN STATUS
B0h	DBh	SMART ENABLE/DISABLE AUTOMATIC OFF-LINE
B1h		DEVICE CONFIGURATION OVERLAY
B1h	C0h	DEVICE CONFIGURATION RESTORE
B1h	C1h	DEVICE CONFIGURATION FREEZE LOCK
B1h	C2h	DEVICE CONFIGURATION IDENTIFY
B1h	C3h	DEVICE CONFIGURATION SET
B1h	C4h	DEVICE CONFIGURATION IDENTIFY DMA
B1h	C5h	DEVICE CONFIGURATION SET DMA
B4	ŀh	SANITIZE DEVICE
B4h	00h	SANITIZE STATUS EXT
B4h	11h	CRYPTO SCRAMBLE EXT (SED model only)
B4h	12h	BLOCK ERASE EXT
B4h	20h	SANITIZE FREEZE LOCK EXT
C4	ŀh	READ MULTIPLE
C5h		WRITE MULTIPLE
C6h		SET MULTIPLE MODE



Op-Code			Command Description		
C8	Sh	READ DI	MA		
C9h		READ DI	MA without retry		
CAh		WRITE D	DMA		
CBh		WRITE DMA without retry			
CEh		WRITE MULTIPLE FUA EXT			
E0h		STANDBY IMMEDIATE			
E1h		IDLE IMMEDIATE			
E2h		STANDBY			
E3h		IDLE			
E4h		READ BUFFER			
E5h		CHECK P	POWER MODE		
E6	5h	SLEEP			
E7	'h	FLUSH C	ACHE		
E8	Sh	WRITE B	BUFFER		
E9h		READ BU	JFFER DMA		
EA	ιh	FLUSH C	ACHE EXT		
EB	Sh	WRITE BUFFER DMA			
ECh		IDENTIFY DEVICE			
EF	h	SET FEAT	TURES		
EFh	02h	Enable volatile write cache			
EFh	03h	Set transfer mode			
EFh	05h	Enable APM feature set			
EFh	10h	Enabl	e Serial ATA feature set		
EFh	10h	02h	Enable DMA Setup FIS Auto-Activate optimization		
EFh	10h	03h	Enable Device-initiated interface power state (DIPM) transitions		
EFh	10h	06h	Enable Software Settings Preservation(SSP)		
EFh	10h	07h	Enable Device Automatic Partial to Slumber transitions		
EFh	10h	09h	Enable Device Sleep		
EFh	55h	Disable read look-ahead			
EFh	66h	Disable reverting to P-On default			
EFh	82h	Disab	le volatile write cache		
EFh	85h	Disable APM feature set			
EFh	90h	Disable Serial ATA feature set			
EFh	90h	02h	Disable DMA Setup FIS Auto-Activate optimization		
EFh	90h	03h	Disable Device-initiated interface power state (DIPM) transitions		
EFh	90h	06h	Software Settings Preservation(SSP)		



Op-Code			Command Description			
EFh	90h	07h	Disable Device Automatic Partial to Slumber transitions			
EFh	90h	09h	Disable Device Sleep			
EFh	AAh	Enable read look-ahead				
EFh	CCh	Enable reverting to P-On default				
F1	F1h		SECURITY SET PASSWORD			
F2	F2h		Y UNLOCK			
F3h		SECURIT	Y ERASE PREPARE			
F4h		SECURITY ERASE UNIT				
F5h		SECURITY FREEZE LOCK				
F6h		SECURIT	Y DISABLE PASSWORD			
F8	F8h		READ NATIVE MAX ADDRESS			
F9h		SET MAX	X ADDRESS			
F9h	01h	SET IV	1AX SET PASSWORD			
F9h	02h	SET IV	1AX LOCK			
F9h	03h	SET IV	1AX UNLOCK			
F9h	04h	SET IV	1AX FREEZE LOCK			
F9h	05h	SET MAX SET PASSWORD DMA				
F9h	06h	SET MAX UNLOCK DMA				



# 10. Revision History

Rev.	Description	Date
1.0.6	Editorial Changes	Oct.22, 2014
1.0.5	Editorial Changes	Aug.8, 2014
1.0.4	Editorial Changes	Jul.16, 2014
1.0.3	Initial Release	Apr.25, 2014



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